TOSHIBA Field Effect Transistor Silicon P Channel MOS Type (High Speed U-MOSII)

TPC8106-H

High Speed and High Efficiency DC-DC Converters
Lithium Ion Battery Applications
Notebook PC Applications
Portable Equipment Applications

• Small footprint due to small and thin package

• High speed switching

• Small gate charge : Qg = 52 nC (typ.)

• Low drain–source ON resistance $: RDS(ON) = 14 \text{ m}\Omega \text{ (typ.)}$

 $\bullet~$ High forward transfer admittance ~ : |Yfs| = 16.6 S (typ.)

• Low leakage current $: I_{DSS} = -10 \mu A \text{ (max) (V}_{DS} = -30 \text{ V)}$

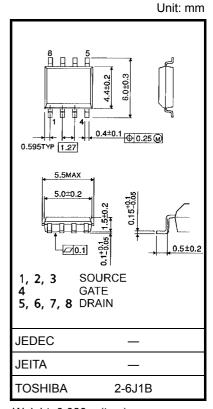
• Enhancement-mode : $V_{th} = -0.8 \sim -2.0 \text{ V (V}_{DS} = -10 \text{ V}, I_D = -1 \text{ mA)}$

Maximum Ratings (Ta = 25°C)

Characte	ristics	Symbol	Rating	Unit	
Drain-source voltage		V_{DSS}	-30	V	
Drain-gate voltage (R	k _{GS} = 20 kΩ)	V_{DGR}	-30	V	
Gate-source voltage		V _{GSS}	±20	V	
Drain current	DC (Note 1)	ID	-10	Α	
Diam current	Pulse (Note 1)	I_{DP}	-40	^	
Drain power dissipati	on (t = 10 s) (Note 2a)	P_{D}	2.4	W	
Drain power dissipati	on (t = 10 s) (Note 2b)	P _D	1.0	W	
Single pulse avalance	ne energy (Note 3)	E _{AS}	130	mJ	
Avalanche current		I _{AR}	-10	Α	
Repetitive avalanche (energy Note 2a) (Note 4)	E _{AR}	0.24	mJ	
Channel temperature		T _{ch}	150	°C	
Storage temperature	range	T _{stg}	−55 to 150	°C	

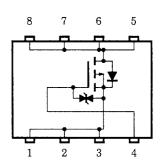
Note: For (Note 1), (Note 2), (Note 3) and (Note 4), please refer to the next page.

This transistor is an electrostatic sensitive device. Please handle with caution.



Weight: 0.080 g (typ.)

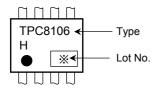
Circuit Configuration



Thermal Characteristics

Characteristics	Symbol	Max	Unit	
Thermal resistance, channel to ambient (t = 10 s) (Note 2a)	R _{th (ch-a)}	52.1	°C/W	
Thermal resistance, channel to ambient (t = 10 s) (Note 2b)	R _{th (ch-a)}	125	°C/W	

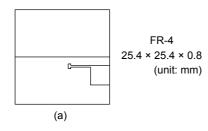
Marking (Note 5)

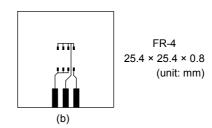


Note 1: Please use devices on condition that the channel temperature is below 150°C.

Note 2: (a) Device mounted on a glass-epoxy board (a)

(b) Device mounted on a glass-epoxy board (b)



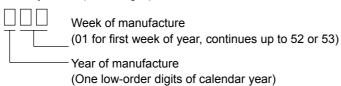


Note 3: V_{DD} = -24 V, T_{ch} = 25°C (initial), L = 0.1 mH, R_G = 25 Ω , I_{AR} = -10 A

Note 4: Reptitve rating; pulse width limited by maximum channel temperature

Note 5: ● on lower left of the marking indicates Pin 1.

* Weekly code: (Three digits)



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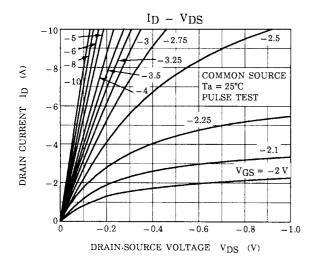
Electrical Characteristics (Ta = 25°C)

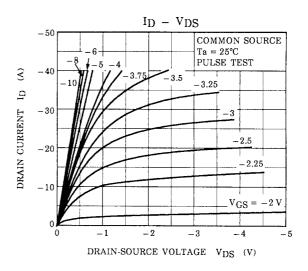
Charac	cteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	ırrent	I _{GSS}	V _{GS} = ±16 V, V _{DS} = 0 V	_	_	±10	μΑ
Drain cut-off cu	rrent	I _{DSS}	V _{DS} = -30 V, V _{GS} = 0 V	_	_	10	μA
Drain-source breakdown voltage		V (BR) DSS	$I_D = -10 \text{ mA}, V_{GS} = 0 \text{ V}$	-30	_	_	V
		V (BR) DSX	$I_D = -10 \text{ mA}, V_{GS} = 20 \text{ V}$	-15	_	_	
Gate threshold v	/oltage	V _{th}	V _{DS} = -10 V, I _D = -1 mA	-0.8	_	-2.0	V
Drain-source ON resistance		R _{DS (ON)}	$V_{GS} = -4 \text{ V}, I_D = -5 \text{ A}$	_	24	30	- mΩ
		R _{DS} (ON)	V _{GS} = -10 V, I _D = -5 A	_	14	20	
Forward transfe	r admittance	Y _{fs}	V _{DS} = -10 V, I _D = -5 A	8.3	16.6	_	S
Input capacitano	ce	C _{iss}			2160	_	
Reverse transfer capacitance		C _{rss}	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	_	530	_	pF
Output capacitance		Coss		_	720	_	
Switching time	Rise time	t _r	$V_{GS} = \frac{0 \text{ V}}{10 \text{ V}} = \frac{10 \text{ F}}{10 \text{ V}} = \frac{10 \text{ V}}{10 \text{ V}$	_	12	_	
	Turn-on time	t _{on}		_	20	_	
	Fall time	t _f		_	100	_	ns
	Turn-off time	t _{off}		_	250	_	
Total gate charge (Gate-source plus gate-drain)		Qg		_	52	_	
Gate-source charge		Q _{gs}	$V_{DD} \approx -24 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -10 \text{ A}$		38	_	nC
Gate-drain ("miller") charge		Q_{gd}		_	14	_	

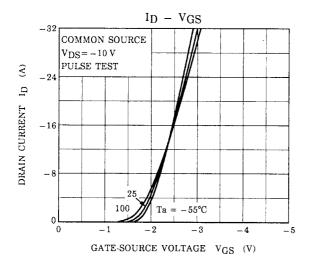
Source-Drain Ratings and Characteristics (Ta = 25°C)

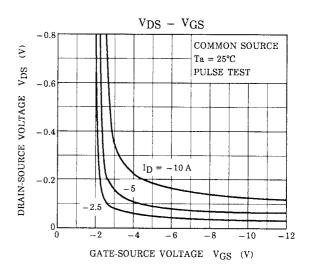
Charact	teristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Drain reverse current	Pulse (Note 1)	I _{DRP}	_	_	_	-40	Α
Forward voltage	Itage (diode) V_{DSF} $I_{DR} = -10 \text{ A}, V_{GS} = 0 \text{ V}$		1		1.2	V	

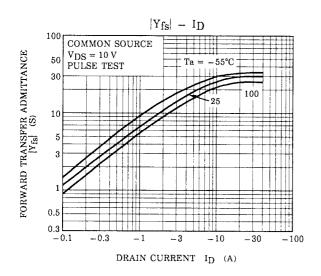
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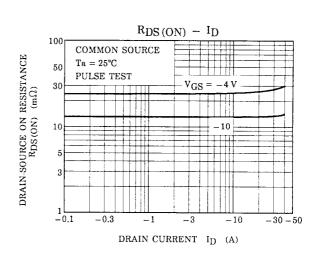


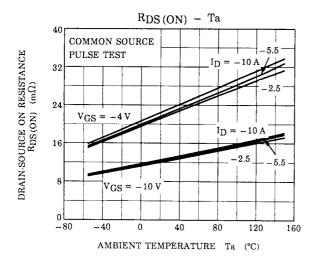


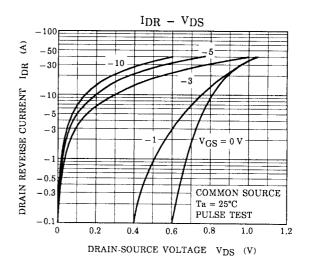


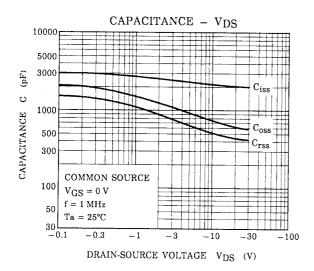


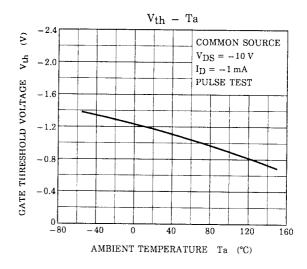


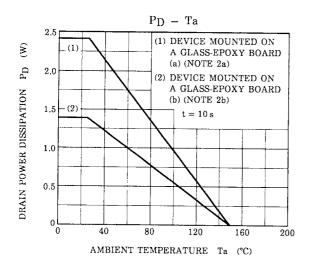


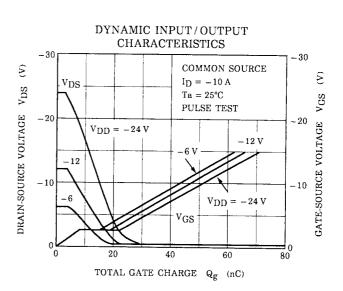




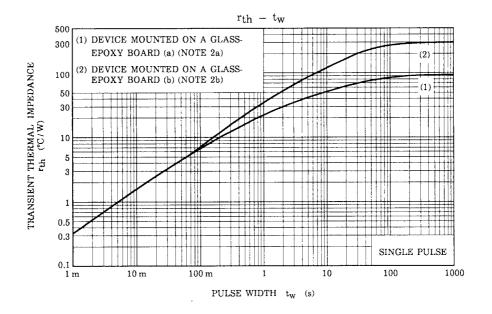


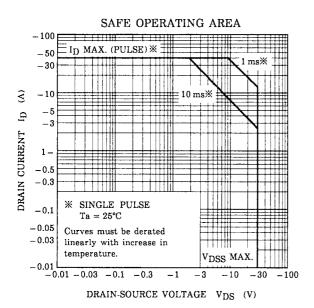


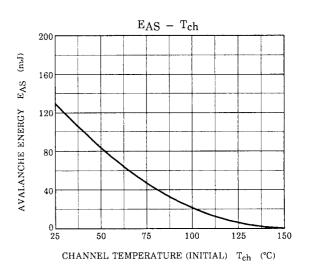


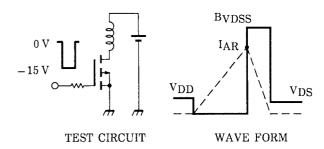


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$$\begin{array}{l} T_{ch} = 25^{\circ}C \; (Initial) \\ Peak \; I_{AR} = -10 \; A, \; R_G = 25 \; \Omega \end{array} \; E_{AS} = \frac{1}{2} \cdot L \cdot I^2 \cdot \; (\frac{BVDSS}{BVDSS} - V_{DD}) \\ V_{DD} = -24 \; V, \; L = 1.0 \; mH \end{array}$$

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